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U.S. DEPARTMENT OF COMMERCE
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3-1004



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To the Honorable Commissioner of Patent,

Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

1. Yeong Ryeol KIM
2. Ji Jong PARK
3. Jin Yong KIM
4. Joong Whan LEE

Additional name(s) of conveying
party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

NAME: KMAC

ADDRESS: 104-11 Munji-dong, Yusong-gu
Daejeon-city, Republic of Korea

3. Name of Conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution/Effective Date: March 2, 2004

Additional name(s) & addresses(es) attached?
☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: March 2, 2004

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No5. Name and address of party to whom correspondence
concerning document should be mailed:

Name:
Internal Address: Rothwell, Figg, Ernst & Manbeck
Suite 800
Street Address: 1425 K St., N.W.
City: Washington,
State: D.C. Zip: 20005
Telephone No.: 202/783-6040
Facsimile No.: 202/783-6031

Attorney Docket No.: 1751-352

6. Total number of applications
and patents involved: 17. Total fee (37 CFR 3.41): . . . \$ 40.00

- ☒ Enclosed
☐ Authorized to be charged to deposit account

8. Deposit account number: 02-2135

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a
true copy of the original document.

G. Franklin Rothwell
Name of Person Signing

G.F. Rothwell
Signature

3.10.04
Date

Total number of pages including cover sheet, attachments and documents: 3

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PATENT
REEL: 015673 FRAME: 0291

ASSIGNMENT OF PATENT APPLICATION

WHEREAS, I/We, KIM, Yeong Ryeol, a citizen of Republic of Korea,
First Named Inventor

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KIM, Jin Yong, a citizen of Republic of Korea,
Third named Inventor, if any

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LEE, Joong Whan, a citizen of Republic of Korea,
Fourth named Inventor, if any

residing at 105-703 Hanbit Apt., Eoeun-dong, Yusong-gu, Daejeon-city, Rep. of Korea,
Address

ASSIGNOR(S), am/are the inventor(s) of an invention in (insert title)

**APPARATUS FOR MEASURING THICKNESS PROFILE AND REFRACTIVE INDEX DISTRIBUTION
 OF MULTIPLE LAYERS OF THIN FILMS BY MEANS OF TWO-DIMENSIONAL REFLECTOMETRY
 AND METHOD OF MEASURING THE SAME**

for which I/we have executed an application for Letters Patent of the United States,

(Check One) ☐ of even date herewith;
☐ U.S. Serial Number _____ filed _____;
☒ International Application No. PCT/KR02/01795 filed 23/September/2002,

and

WHEREAS, KMAC a Korean Corporation of 104-11 Munji-dong, Yusong-gu, Daejeon-city, Rep. of Korea,
Assignee Citizenship or Corporate Status Address

ASSIGNEES, are desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me/us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I/we, the said ASSIGNOR(S) have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said invention, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reexamination certificates, reissues and extensions thereof, and I/we hereby authorize and request the Commissioner of Patents of the United States, to issue all Letters Patent for said invention to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I/WE HEREBY covenant that I/we have the full right to convey the entire interest herein assigned, and that I/we have not executed, and will not execute, any agreement in conflict herewith.

AND I/WE HEREBY further covenant and agree that I/we will communicate to said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me/us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention at the expense of the ASSIGNEES.

IN TESTIMONY WHEREOF, I/we hereunto set my/our hand(s) and seal(s) the day and year set opposite my/our signature(s).

KIM, Yeong Ryeol	<u>Yeong Ryeol Kim</u>	L.S.	Date <u>2 March</u> , 2004
RARK, Ji Jong	<u>Si Jong park</u>	L.S.	Date <u>2 March</u> , 2004
KIM, Jin Yong	<u>Jin Yong Kim</u>	L.S.	Date <u>2 March</u> , 2004
LEE, Joong Whan	<u>Joong-Whan Lee</u>	L.S.	Date <u>2 March</u> , 2004

Witness:

<u>Kim, Hyun-Jung</u>	<u>KIM, Hyun Jung</u>	<u>2 March 2004</u>
<small>Name</small>	<small>Name</small>	<small>Date</small>
<u>yeunghee</u>	<u>Jeon</u>	<u>2/ Mar/2004</u>
<small>Name</small>	<small>Name</small>	<small>Date</small>